

- Member of the Texas Instruments Widebus™ Family
- DOC™ (Dynamic Output Control) Circuit Dynamically Changes Output Impedance, Resulting in Noise Reduction Without Speed Degradation
- Less Than 2-ns Maximum Propagation Delay at 2.5-V and 3.3-V  $V_{CC}$
- Dynamic Drive Capability Is Equivalent to Standard Outputs With  $I_{OH}$  and  $I_{OL}$  of  $\pm 24$  mA at 2.5-V  $V_{CC}$
- Overvoltage-Tolerant Inputs/Outputs Allow Mixed-Voltage-Mode Data Communications
- $I_{off}$  Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)

## description/ordering information

A Dynamic Output Control (DOC) circuit is implemented, which, during the transition, initially lowers the output impedance to effectively drive the load and, subsequently, raises the impedance to reduce noise. Figure 1 shows typical  $V_{OL}$  vs  $I_{OL}$  and  $V_{OH}$  vs  $I_{OH}$  curves to illustrate the output impedance and drive capability of the circuit. At the beginning of the signal transition, the DOC circuit provides a maximum dynamic drive that is equivalent to a high-drive standard-output device. For more information, refer to the TI application reports, *AVC Logic Family Technology and Applications*, literature number SCEA006, and *Dynamic Output Control (DOC™) Circuitry Technology and Applications*, literature number SCEA009.

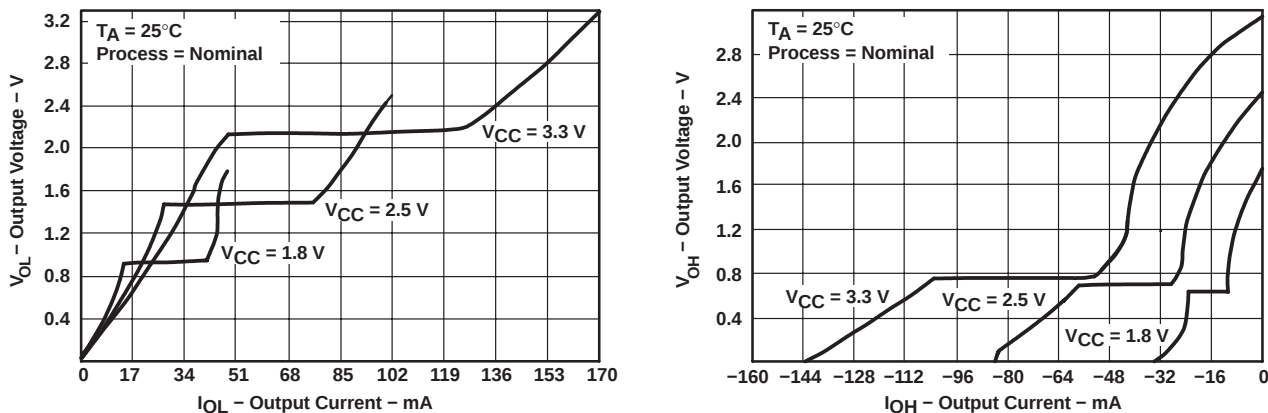


Figure 1. Output Voltage vs Output Current

## ORDERING INFORMATION

| $T_A$         | PACKAGE†              |               | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|---------------|-----------------------|---------------|-----------------------|------------------|
| -40°C to 85°C | TSSOP – DGG           | Tape and reel | SN74AVC16244DGGR      | AVC16244         |
|               | TVSOP – DGV           | Tape and reel | SN74AVC16244DGVR      | CVA244           |
|               | VFBGA – GQL           | Tape and reel | SN74AVC16244GQLR      | CVA244           |
|               | VFBGA – ZQL (Pb-free) |               | SN74AVC16244ZQLR      |                  |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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# SN74AVC16244

## 16-BIT BUFFER/DRIVER

### WITH 3-STATE OUTPUTS

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#### description/ordering information (continued)

This 16-bit buffer/driver is operational at 1.2-V to 3.6-V  $V_{CC}$ , but is designed specifically for 1.65-V to 3.6-V  $V_{CC}$  operation.

The SN74AVC16244 is designed specifically to improve the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

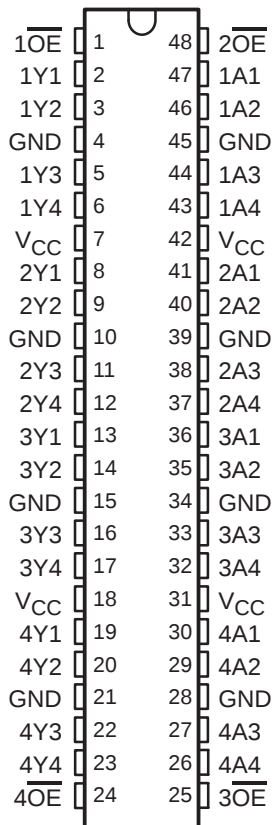
The device can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. It provides true outputs and symmetrical active-low output-enable ( $\overline{OE}$ ) inputs.

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

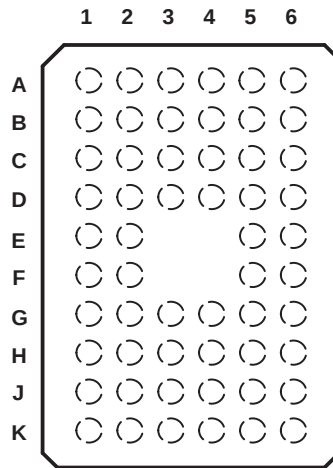
To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

#### terminal assignments

DGG OR DGV PACKAGE  
(TOP VIEW)



**GQL OR ZQL PACKAGE  
(TOP VIEW)**



**terminal assignments**

|   | 1                | 2   | 3        | 4        | 5   | 6                |
|---|------------------|-----|----------|----------|-----|------------------|
| A | $\overline{1OE}$ | NC  | NC       | NC       | NC  | $2\overline{OE}$ |
| B | 1Y2              | 1Y1 | GND      | GND      | 1A1 | 1A2              |
| C | 1Y4              | 1Y3 | $V_{CC}$ | $V_{CC}$ | 1A3 | 1A4              |
| D | 2Y2              | 2Y1 | GND      | GND      | 2A1 | 2A2              |
| E | 2Y4              | 2Y3 |          |          | 2A3 | 2A4              |
| F | 3Y1              | 3Y2 |          |          | 3A2 | 3A1              |
| G | 3Y3              | 3Y4 | GND      | GND      | 3A4 | 3A3              |
| H | 4Y1              | 4Y2 | $V_{CC}$ | $V_{CC}$ | 4A2 | 4A1              |
| J | 4Y3              | 4Y4 | GND      | GND      | 4A4 | 4A3              |
| K | $4\overline{OE}$ | NC  | NC       | NC       | NC  | $3\overline{OE}$ |

NC – No internal connection

**FUNCTION TABLE  
(each 4-bit buffer)**

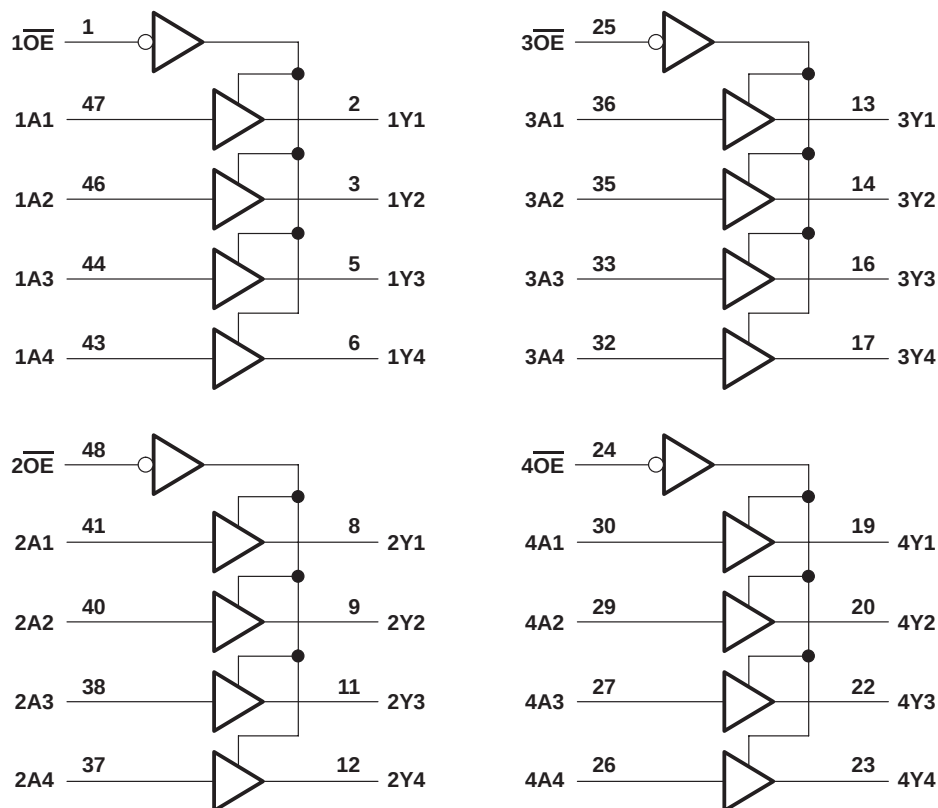
| INPUTS          |   | OUTPUT<br>Y |
|-----------------|---|-------------|
| $\overline{OE}$ | A |             |
| L               | L | L           |
| L               | H | H           |
| H               | X | Z           |

# SN74AVC16244

## 16-BIT BUFFER/DRIVER WITH 3-STATE OUTPUTS

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### logic diagram (positive logic)



### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

|                                                                                                  |                            |
|--------------------------------------------------------------------------------------------------|----------------------------|
| Supply voltage range, $V_{CC}$                                                                   | –0.5 V to 4.6 V            |
| Input voltage range, $V_I$ (see Note 1)                                                          | –0.5 V to 4.6 V            |
| Voltage range applied to any output in the high-impedance or power-off state, $V_O$ (see Note 1) | –0.5 V to 4.6 V            |
| Voltage range applied to any output in the high or low state, $V_O$ (see Notes 1 and 2)          | –0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )                                                      | –50 mA                     |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ )                                                     | –50 mA                     |
| Continuous output current, $I_O$                                                                 | ±50 mA                     |
| Continuous current through each $V_{CC}$ or GND                                                  | ±100 mA                    |
| Package thermal impedance, $\theta_{JA}$ (see Note 3): DGG package                               | 70°C/W                     |
| DGV package                                                                                      | 58°C/W                     |
| GQL package                                                                                      | 42°C/W                     |
| Storage temperature range, $T_{stg}$                                                             | –65°C to 150°C             |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
  2. The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.
  3. The package thermal impedance is calculated in accordance with JESD 51.

**SN74AVC16244**  
**16-BIT BUFFER/DRIVER**  
**WITH 3-STATE OUTPUTS**

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**recommended operating conditions (see Note 4)**

|                  |                                               | MIN                                | MAX                    | UNIT            |      |
|------------------|-----------------------------------------------|------------------------------------|------------------------|-----------------|------|
| V <sub>CC</sub>  | Supply voltage                                | Operating                          | 1.4                    | 3.6             | V    |
|                  |                                               | Data retention only                | 1.2                    |                 |      |
| V <sub>IH</sub>  | High-level input voltage                      | V <sub>CC</sub> = 1.2 V            | V <sub>CC</sub>        |                 | V    |
|                  |                                               | V <sub>CC</sub> = 1.4 V to 1.6 V   | 0.65 × V <sub>CC</sub> |                 |      |
|                  |                                               | V <sub>CC</sub> = 1.65 V to 1.95 V | 0.65 × V <sub>CC</sub> |                 |      |
|                  |                                               | V <sub>CC</sub> = 2.3 V to 2.7 V   | 1.7                    |                 |      |
|                  |                                               | V <sub>CC</sub> = 3 V to 3.6 V     | 2                      |                 |      |
| V <sub>IL</sub>  | Low-level input voltage                       | V <sub>CC</sub> = 1.2 V            | GND                    |                 | V    |
|                  |                                               | V <sub>CC</sub> = 1.4 V to 1.6 V   | 0.35 × V <sub>CC</sub> |                 |      |
|                  |                                               | V <sub>CC</sub> = 1.65 V to 1.95 V | 0.35 × V <sub>CC</sub> |                 |      |
|                  |                                               | V <sub>CC</sub> = 2.3 V to 2.7 V   | 0.7                    |                 |      |
|                  |                                               | V <sub>CC</sub> = 3 V to 3.6 V     | 0.8                    |                 |      |
| V <sub>I</sub>   | Input voltage                                 | 0                                  | 3.6                    | V               |      |
| V <sub>O</sub>   | Output voltage                                | Active state                       | 0                      | V <sub>CC</sub> | V    |
|                  |                                               | 3-state                            | 0                      | 3.6             |      |
| I <sub>OHS</sub> | Static high-level output current <sup>†</sup> | V <sub>CC</sub> = 1.4 V to 1.6 V   | −2                     |                 | mA   |
|                  |                                               | V <sub>CC</sub> = 1.65 V to 1.95 V | −4                     |                 |      |
|                  |                                               | V <sub>CC</sub> = 2.3 V to 2.7 V   | −8                     |                 |      |
|                  |                                               | V <sub>CC</sub> = 3 V to 3.6 V     | −12                    |                 |      |
| I <sub>OLS</sub> | Static low-level output current <sup>†</sup>  | V <sub>CC</sub> = 1.4 V to 1.6 V   | 2                      |                 | mA   |
|                  |                                               | V <sub>CC</sub> = 1.65 V to 1.95 V | 4                      |                 |      |
|                  |                                               | V <sub>CC</sub> = 2.3 V to 2.7 V   | 8                      |                 |      |
|                  |                                               | V <sub>CC</sub> = 3 V to 3.6 V     | 12                     |                 |      |
| Δt/Δv            | Input transition rise or fall rate            | V <sub>CC</sub> = 1.4 V to 3.6 V   | 5                      |                 | ns/V |
| T <sub>A</sub>   | Operating free-air temperature                |                                    | −40                    | 85              | °C   |

<sup>†</sup> Dynamic drive capability is equivalent to standard outputs with  $I_{OH}$  and  $I_{OL}$  of  $\pm 24\text{ mA}$  at  $2.5\text{-V }V_{CC}$ . See Figure 1 for  $V_{OL}$  vs  $I_{OL}$  and  $V_{OH}$  vs  $I_{OH}$  characteristics. Refer to the TI application reports, **AVC Logic Family Technology and Applications**, literature number **SCEA006**, and **Dynamic Output Control (DOC™) Circuitry Technology and Applications**, literature number **SCEA009**.

NOTE 4: All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

# SN74AVC16244

## 16-BIT BUFFER/DRIVER

### WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER        |                | TEST CONDITIONS                                             | V <sub>CC</sub> | MIN                   | TYP <sup>†</sup> | MAX | UNIT |
|------------------|----------------|-------------------------------------------------------------|-----------------|-----------------------|------------------|-----|------|
| V <sub>OH</sub>  |                | I <sub>OHS</sub> = -100 µA                                  | 1.4 V to 3.6 V  | V <sub>CC</sub> - 0.2 |                  |     | V    |
|                  |                | I <sub>OHS</sub> = -2 mA, V <sub>IH</sub> = 0.91 V          | 1.4 V           | 1.05                  |                  |     |      |
|                  |                | I <sub>OHS</sub> = -4 mA, V <sub>IH</sub> = 1.07 V          | 1.65 V          | 1.2                   |                  |     |      |
|                  |                | I <sub>OHS</sub> = -8 mA, V <sub>IH</sub> = 1.7 V           | 2.3 V           | 1.75                  |                  |     |      |
|                  |                | I <sub>OHS</sub> = -12 mA, V <sub>IH</sub> = 2 V            | 3 V             | 2.3                   |                  |     |      |
| V <sub>OL</sub>  |                | I <sub>OLS</sub> = 100 µA                                   | 1.4 V to 3.6 V  | 0.2                   |                  |     | V    |
|                  |                | I <sub>OLS</sub> = 2 mA, V <sub>IL</sub> = 0.49 V           | 1.4 V           | 0.4                   |                  |     |      |
|                  |                | I <sub>OLS</sub> = 4 mA, V <sub>IL</sub> = 0.57 V           | 1.65 V          | 0.45                  |                  |     |      |
|                  |                | I <sub>OLS</sub> = 8 mA, V <sub>IL</sub> = 0.7 V            | 2.3 V           | 0.55                  |                  |     |      |
|                  |                | I <sub>OLS</sub> = 12 mA, V <sub>IL</sub> = 0.8 V           | 3 V             | 0.7                   |                  |     |      |
| I <sub>I</sub>   |                | V <sub>I</sub> = V <sub>CC</sub> or GND                     | 3.6 V           | ±2.5                  |                  |     | µA   |
| I <sub>off</sub> |                | V <sub>I</sub> or V <sub>O</sub> = 3.6 V                    | 0               | ±10                   |                  |     | µA   |
| I <sub>OZ</sub>  |                | V <sub>O</sub> = V <sub>CC</sub> or GND                     | 3.6 V           | ±10                   |                  |     | µA   |
| I <sub>CC</sub>  |                | V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0 | 3.6 V           | 40                    |                  |     | µA   |
| C <sub>i</sub>   | Control inputs | V <sub>I</sub> = V <sub>CC</sub> or GND                     | 2.5 V           | 3.5                   |                  |     | pF   |
|                  |                |                                                             | 3.3 V           | 3.5                   |                  |     |      |
|                  | Data inputs    | V <sub>I</sub> = V <sub>CC</sub> or GND                     | 2.5 V           | 6                     |                  |     |      |
|                  |                |                                                             | 3.3 V           | 6                     |                  |     |      |
| C <sub>O</sub>   | Outputs        | V <sub>O</sub> = V <sub>CC</sub> or GND                     | 2.5 V           | 6.5                   |                  |     | pF   |
|                  |                |                                                             | 3.3 V           | 6.5                   |                  |     |      |

<sup>†</sup> Typical values are measured at T<sub>A</sub> = 25°C.

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 2)

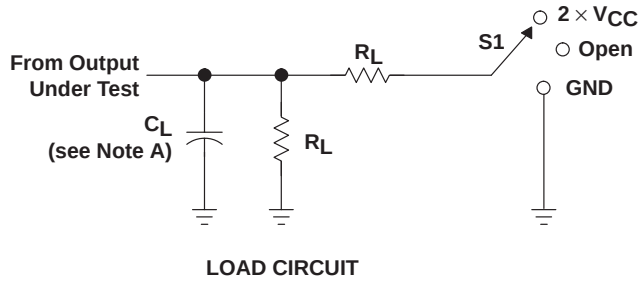
| PARAMETER        | FROM (INPUT)           | TO (OUTPUT) | V <sub>CC</sub> = 1.2 V | V <sub>CC</sub> = 1.5 V ± 0.1 V |     | V <sub>CC</sub> = 1.8 V ± 0.15 V |     | V <sub>CC</sub> = 2.5 V ± 0.2 V |     | V <sub>CC</sub> = 3.3 V ± 0.3 V |     | UNIT |
|------------------|------------------------|-------------|-------------------------|---------------------------------|-----|----------------------------------|-----|---------------------------------|-----|---------------------------------|-----|------|
|                  |                        |             | TYP                     | MIN                             | MAX | MIN                              | MAX | MIN                             | MAX | MIN                             | MAX |      |
| t <sub>pd</sub>  | A                      | Y           | 3.1                     | 0.6                             | 3.3 | 0.7                              | 2.9 | 0.6                             | 1.9 | 0.5                             | 1.7 | ns   |
| t <sub>en</sub>  | $\overline{\text{OE}}$ | Y           | 7.6                     | 1.4                             | 8   | 1.3                              | 6.8 | 0.9                             | 4   | 0.7                             | 3.5 | ns   |
| t <sub>dis</sub> | $\overline{\text{OE}}$ | Y           | 7.2                     | 1.7                             | 7.3 | 1.6                              | 6.2 | 1                               | 4.3 | 1                               | 3.5 | ns   |

operating characteristics, T<sub>A</sub> = 25°C

| PARAMETER       |                               | TEST CONDITIONS  | V <sub>CC</sub> = 1.8 V | V <sub>CC</sub> = 2.5 V | V <sub>CC</sub> = 3.3 V | UNIT |
|-----------------|-------------------------------|------------------|-------------------------|-------------------------|-------------------------|------|
|                 |                               |                  | TYP                     | TYP                     | TYP                     |      |
| C <sub>pd</sub> | Power dissipation capacitance | Outputs enabled  | 23                      | 27                      | 33                      | pF   |
|                 |                               | Outputs disabled | 0.1                     | 0.1                     | 0.1                     |      |

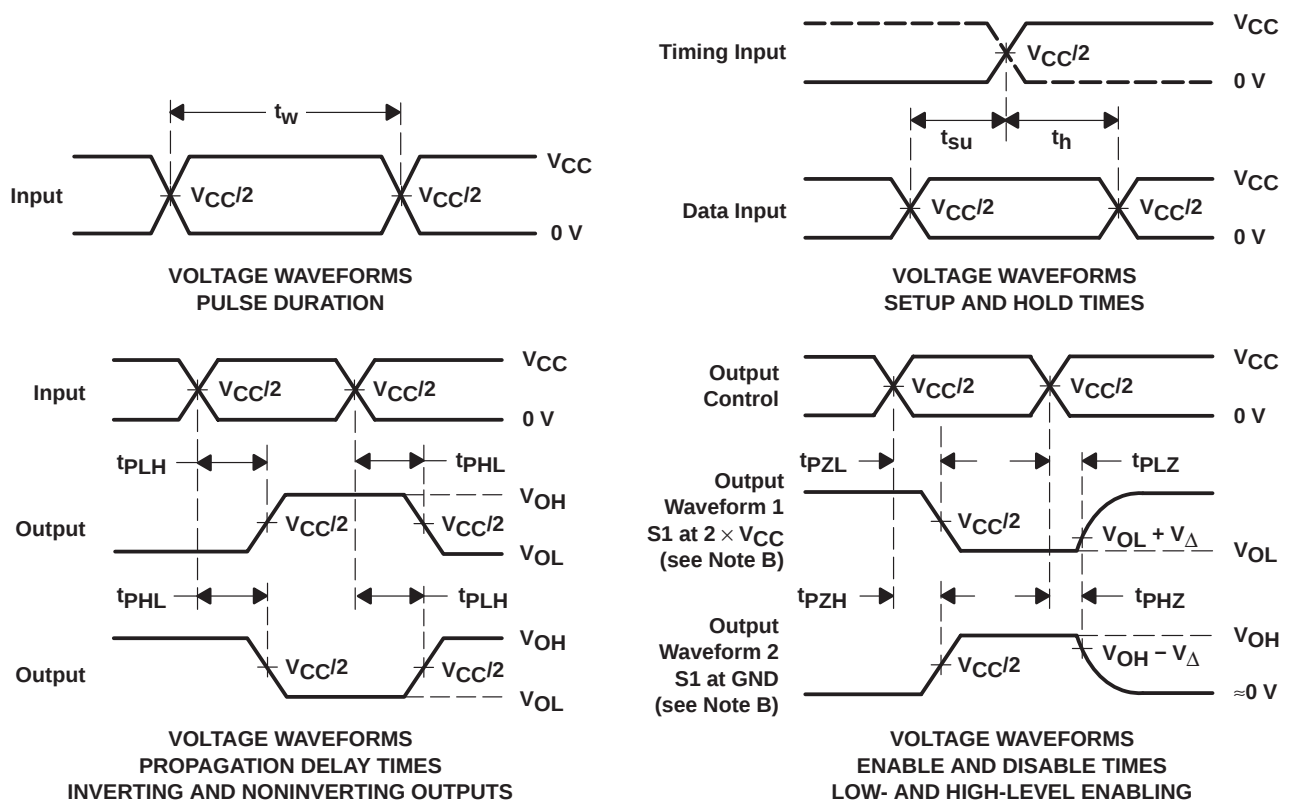


## PARAMETER MEASUREMENT INFORMATION



| TEST              | S1                |
|-------------------|-------------------|
| $t_{PLH}/t_{PHL}$ | Open              |
| $t_{PLZ}/t_{PZL}$ | $2 \times V_{CC}$ |
| $t_{PHZ}/t_{PZH}$ | GND               |

| $V_{CC}$           | $C_L$ | $R_L$        | $V_{\Delta}$ |
|--------------------|-------|--------------|--------------|
| 1.2 V              | 15 pF | 2 k $\Omega$ | 0.1 V        |
| 1.5 V $\pm$ 0.1 V  | 15 pF | 2 k $\Omega$ | 0.1 V        |
| 1.8 V $\pm$ 0.15 V | 30 pF | 1 k $\Omega$ | 0.15 V       |
| 2.5 V $\pm$ 0.2 V  | 30 pF | 500 $\Omega$ | 0.15 V       |
| 3.3 V $\pm$ 0.3 V  | 30 pF | 500 $\Omega$ | 0.3 V        |



- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ , slew rate  $\geq$  1 V/ns.
  - The outputs are measured one at a time, with one transition per measurement.
  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
  - All parameters and waveforms are not applicable to all devices.

Figure 2. Load Circuit and Voltage Waveforms

## DGV (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

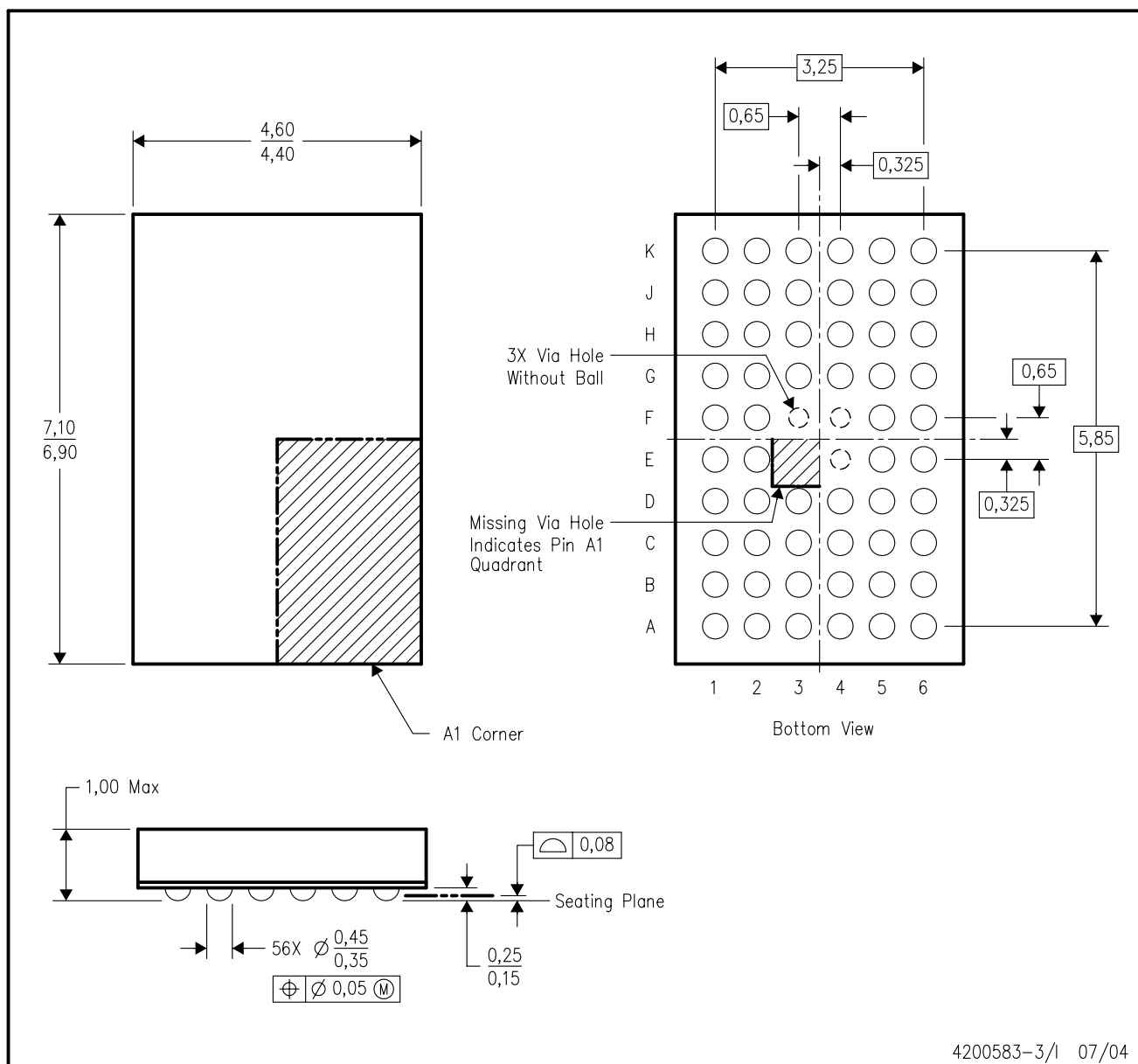
24 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.  
 D. Falls within JEDEC: 24/48 Pins – MO-153  
 14/16/20/56 Pins – MO-194

GQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



4200583-3/1 07/04

NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-225 variation BA.
- D. This package is tin-lead (SnPb). Refer to the 56 ZQL package (drawing 4204437) for lead-free.

## DGG (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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| Microcontrollers | <a href="http://microcontroller.ti.com">microcontroller.ti.com</a> | Security            | <a href="http://www.ti.com/security">www.ti.com/security</a>             |
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